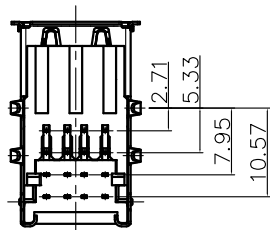
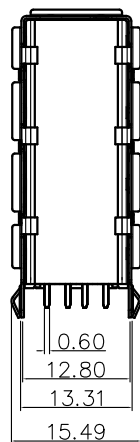
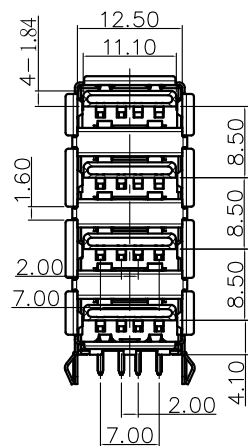
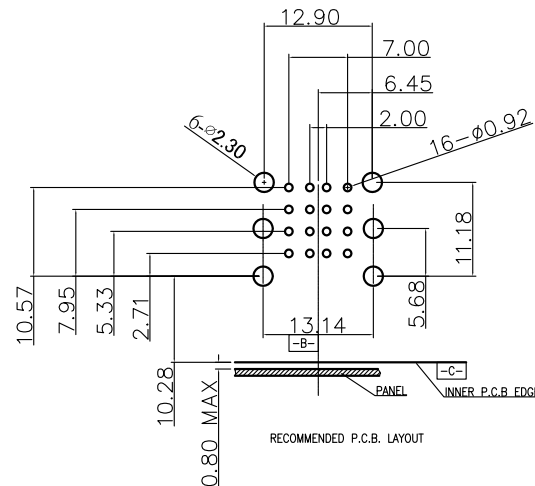
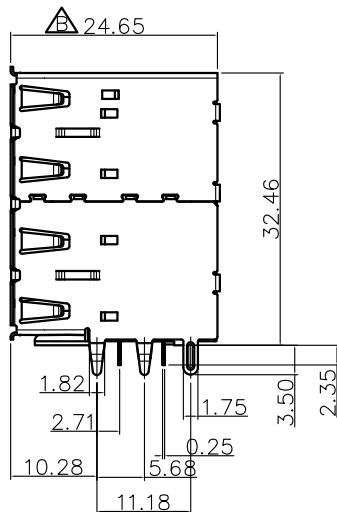
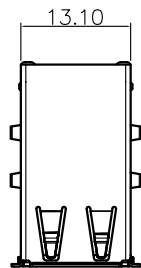
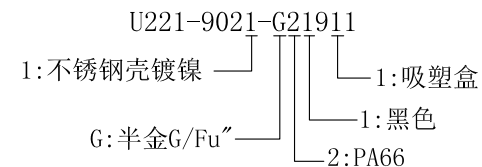


REV.	ECN.NO.		APPD.
A	NEW DWG	2018.12.04	ZFY
B	E2021031101	2021.03.11	LJF



NOTES:

- MATERIAL:
 - Housing:thermoplastic plastics
 - terminals:Copper Alloy
Gold plated in contact area:
Tin plated in termination
Nickel Plated overall
 - Shell:Steel&Copper Alloy
Nickel Plated overall
- ELECTRICAL CHARACTERISTICS:
 - Rating Current :1.5 Ampere
 - Rating Voltage :30 V Max
 - Contact Resistance:30 Milli ohms
 - Insulation Resistance:1000 Mega ohms Min.
- MECHANICAL CHARACTERISTICS:
 - Connector Mating force: 35N MAX(3.57Kgf)
 - Connector Unmating force:10N min(1.02Kgf)
 - Durability:1500Cycles.
- ENVIRONMENT CHARACTERISTICS:
 - Operating temperature:-0°C to +50°C
 - Storage temperature:-20°C to +60°C



TOLERANCE UNLESS OTHERWISE SPECIFIED	
.XXX ±0.15	.X' ±5°
.XX ±0.20	.XX' ±2°
.X ±0.30	

FLW 深圳市华联威电子科技有限公司

HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.

APPROVED		PART NAME:	USB 2.0 AF 90度四层结构			
CHECKED		PART No:	U221-9021-G21911			C
DRAWN	Lijinfeng	PROJECTION:	UNIT:	SCALE	SHEET	REV.
DATE	2021.03.11		mm	1:1	10F1	B